

STATUS OF CLAIMS

Claims 1-27 are pending.

PLEASE AMEND THE CLAIMS AS FOLLOWS:

²⁵ ~~25~~ The method of Claim ¹⁷ ~~17~~ wherein said low dielectric constant material is a hydrogen silsesquioxane spin-on-glass dielectric material.

²⁶ ~~26~~ The method of Claim ¹⁷ ~~17~~ wherein said low dielectric constant material is a carbon bonded hydrogen silsesquioxane spin-on-glass dielectric material.

²⁷ ~~27~~ The method of Claim ¹⁷ ~~17~~ wherein said low dielectric constant material is a carbon bonded fluorocarbon silsesquioxane spin-on-glass dielectric material.

Add claim 28 as follows:

²⁸ ~~28~~ The method of Claim ¹⁷ ~~17~~ wherein said low dielectric constant material is a silsesquioxane spin-on-glass dielectric material.